

Features

- Operation Voltage: 2.5V~25V
- Directly Drive 1~10 Series LED
- Shutdown Current: 3uA
- Fixed 1.2MHz Switching Frequency
- 600mA Constant Output Current Capability
- Built in High Frequency Power Transistor
- Built in Schottky Diode
- High Efficiency up to 87%
- Excellent line and load regulation
- EN PIN TTL ON/OFF capability
- Dimming Control Using a PWM Signal in EN PIN
- Boost or SEPIC Topologies
- Built in LED open circuit protection function
- Built in thermal shutdown function
- Device HBM ESD Classification Level Class3A
- Available in DFN3*3-8 package

General Description

XL6103 is a built in high frequency power transistor and Schottky diode Boost LED constant current driver, fixed 1.2MHz frequency PWM, can support input operating voltage range of 2.5V~25V. XL6103 has high precision constant current output to drive the LED, and built in frequency compensation circuitry allows the use of small external components at a price suitable for lowering the cost of the entire power supply system and reduce the printed circuit board space. The low feedback voltage of 200mV reduces the power consumption of the external sampling resistor, and the EN pin supports both TTL ON/OFF and PWM dimming from 0 to 100%. Suitable for very low quiescent current and ultra-small size applications.

Applications

- Screen Backlight LED Driver
- Wearable Portable Electronic Devices
- Digital Cameras
- PDAs and Other Handheld Devices
- Auxiliary Displays

Typical application schematic

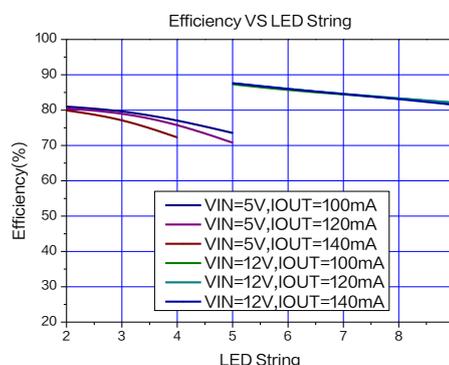
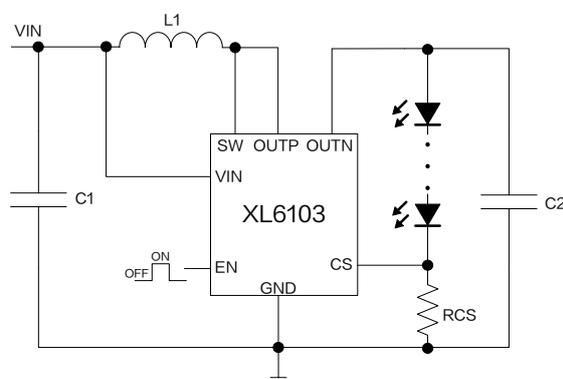


Figure1. XL6103 Typical application schematic and efficiency curve

Pin Configurations



Figure2. Pin Configuration of XL6103

Table 1. Pin Description

Pin Number	Pin Name	Description
1	VIN	Supply Voltage Input Pin. XL6103 operates from 2.5V to 25V DC voltage. Bypass Vin to GND with a suitably large capacitor to eliminate noise on the input.
2	NC	No Connected.
3	OUTN	Output Pin. Internal Schottky diode cathode Pin.
4	EN	Enable Pin. Drive EN pin high to turn on the device, drive it low to turn it off. Floating is default high. Connect to a PWM signal to achieve LEDs brightness dimming.
5	CS	Output constant current sense Pin. The CS reference voltage is 200mV.
6	GND	Ground Pin.
7	OUTP	Internal Schottky diode anode Pin.
8	SW	Power Switch Pin.

Ordering Information

Order Information	Marking ID	Package Type	Eco Plan	Packing Type Supplied As
XL6103	XL6103	DFN3*3-8	RoHS & HF	5000 Units on Reel

Function Block

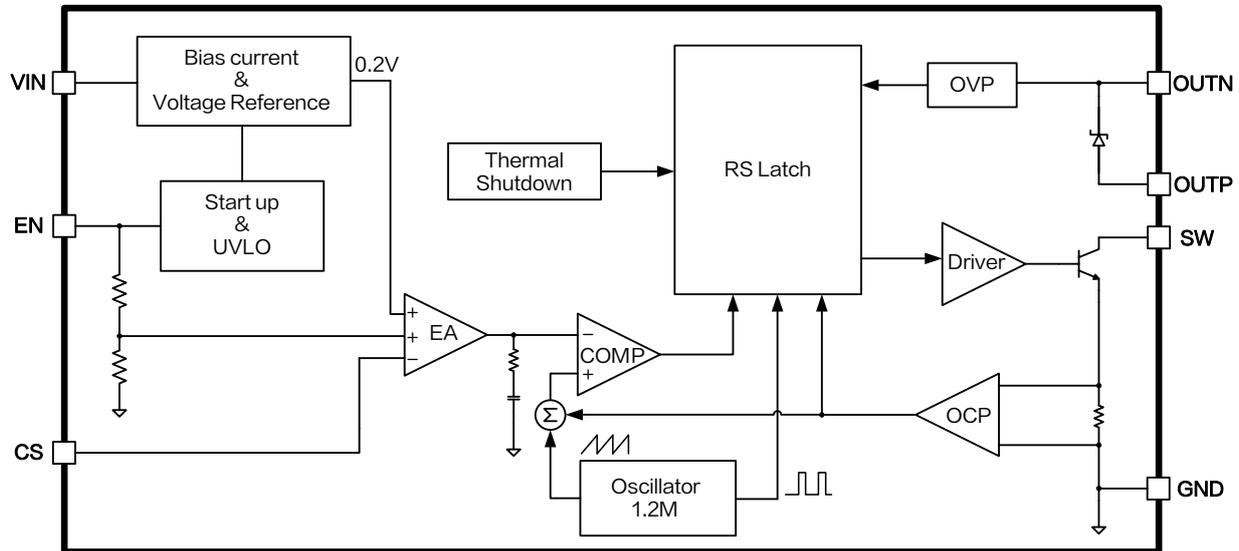


Figure3. Function Block Diagram of XL6103

Absolute Maximum Ratings (Note1)

Parameter	Symbol	Value	Unit
Input Voltage	V_{IN}	-0.3~32	V
EN Pin Voltage	V_{EN}	-0.3~ V_{IN}	V
Current Sense Pin Voltage	V_{CS}	-0.3~ V_{IN}	V
Switch Pin Voltage	V_{SW}	-0.3~40	V
OUTN Pin Voltage	V_{OUTN}	-0.3~40	V
Power Dissipation	P_D	250	mW
Thermal Resistance (DFN3*3-8) (Junction to Ambient, No Heatsink, Free Air)	R_{JA}	55	°C/W
Maximum Junction Temperature	T_J	-40~150	°C
Operating Junction Temperature	T_J	-40~125	°C
Storage Temperature	T_{STG}	-65~150	°C
Lead Temperature (Soldering, 10 sec)	T_{LEAD}	260	°C
ESD (HBM)		>4000	V

Note1: Stresses greater than those listed under Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

600mA 1.2MHz 36V Built in SBD Boost LED Constant Current Driver

XL6103

XL6103 Electrical Characteristics

$T_A = 25^\circ\text{C}$; system parameters test circuit figure5, unless otherwise specified.

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
V_{CS}	Current Sense Voltage	$V_{IN} = 5V, V_{OUT} = 9.9V$ $I_{LED} = 20mA$	194	200	206	mV
η	Efficiency	$V_{IN} = 5V, V_{OUT} = 13.2V$ $I_{LED} = 20mA$	-	78.0	-	%
η	Efficiency	$V_{IN} = 12V, V_{OUT} = 16.5V$ $I_{LED} = 100mA$	-	87.3	-	%

Electrical Characteristics (DC Parameters)

$T_A = 25^\circ\text{C}, V_{IN} = 3V$; system parameters test circuit figure4, unless otherwise specified.

Parameters	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Input operation voltage	V_{IN}		2.5		25	V
Shutdown Supply Current	I_S	$V_{EN} = 0V$ OUTN flowing		3		μA
Quiescent Supply Current	I_Q	$V_{CS} = 2V$		2.3		mA
Oscillator Frequency	F_{OSC}		0.96	1.20	1.44	MHz
Switch Current Limit	I_L	$V_{CS} = 0V$		650		mA
Switch V_{CE} Saturation Voltage	V_{SAT}	$I_{SW} = 300mA$		0.3		V
Schottky Forward Drop	V_F	$I_F = 300mA$		0.8		V
EN Pin Threshold	V_{EN_H}	High(ON)	2.0			V
	V_{EN_L}	Low(OFF)			0.5	
Max. Duty Cycle	D_{MAX}	$V_{CS} = 0V$		90		%
Over Voltage Protection	V_{OUT}	OUTN OPEN ($V_{CS} = 0V$)		36		V
Thermal Shutdown Temperature	T_{SD}			150		$^\circ\text{C}$

Typical System Application–Single Li Battery to Drive LED

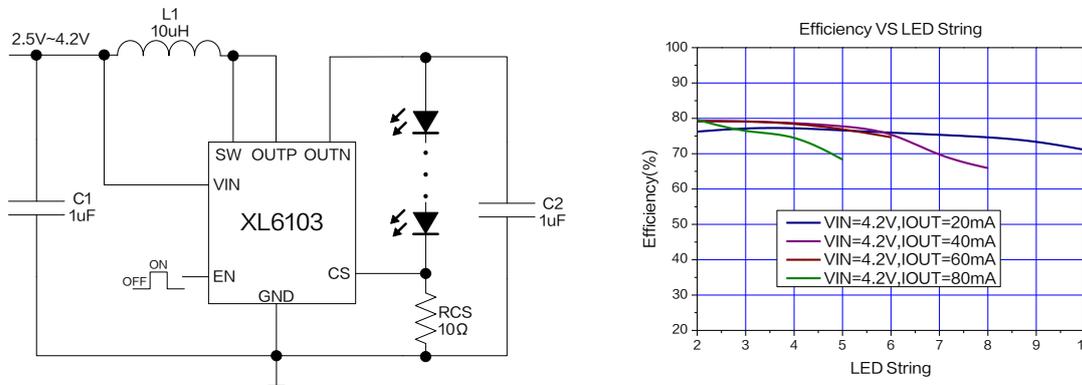


Figure4. XL6103 System Application and efficiency curve

Table 2. Figure4 Typical System Application Schematic Boom

Qty	Ref Des	Description	Mfg Part Number	Mfg
1	L1	10uH,0.73A,Inductor,3*3	ANR3015T100M	APV
2	C1,C2	1uF,50V,Ceramic,X7R,0603	0603B105K500NT	Fenghua
1	RCS	10Ω,1%,1/8W,Thick Film,0805	RS-05K100FT	Fenghua

Typical System Application–Two Li Batteries to Drive LED

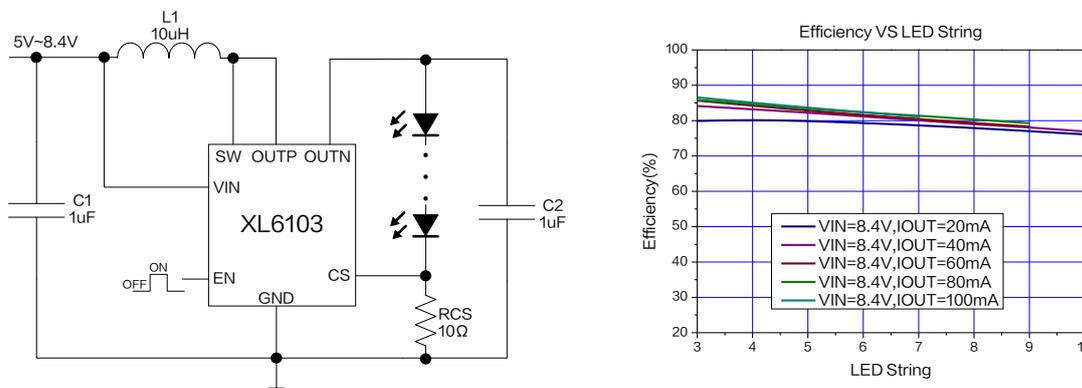


Figure5. XL6103 System Application and efficiency curve

Table 3. Figure5 Typical System Application Schematic Boom

Qty	Ref Des	Description	Mfg Part Number	Mfg
1	L1	10uH,0.73A,Inductor,3*3	ANR3015T100M	APV
2	C1,C2	1uF,50V,Ceramic,X7R,0603	0603B105K500NT	Fenghua
1	RCS	10Ω,1%,1/8W,Thick Film,0805	RS-05K100FT	Fenghua

Typical System Application– BOOST Topology to Drive LED

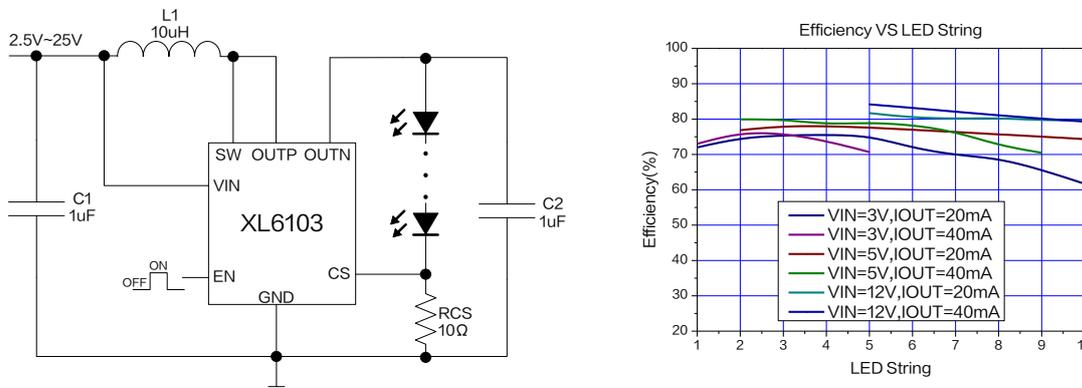


Figure6. XL6103 System Application and efficiency curve

Table 4. Figure6 Typical System Application Schematic Boom

Qty	Ref Des	Description	Mfg Part Number	Mfg
1	L1	10uH,0.73A,Inductor,3*3	ANR3015T100M	APV
2	C1,C2	1uF,50V,Ceramic,X7R,0603	0603B105K500NT	Fenghua
1	RCS	10Ω,1%,1/8W,Thick Film,0805	RS-05K100FT	Fenghua

Typical System Application– SEPIC Topology to Drive LED

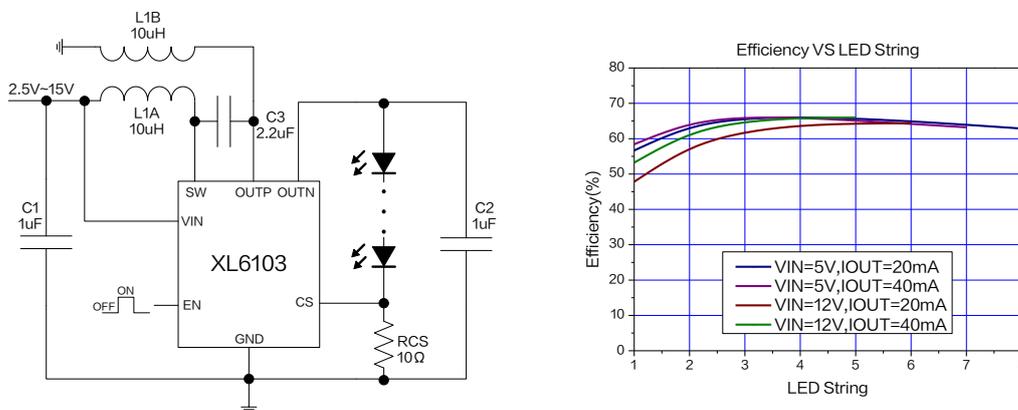


Figure7. XL6103 System Application and efficiency curve

Table 5. Figure7 Typical System Application Schematic Boom

Qty	Ref Des	Description	Mfg Part Number	Mfg
2	L1A,L1B	10uH,0.73A,Inductor,3*3	ANR3015T100M	APV
2	C1,C2	1uF,50V,Ceramic,X7R,0603	0603B105K500NT	Fenghua
1	C3	2.2uF,50V,Ceramic,X7R,0805	0805X225K500NT	Fenghua
1	RCS	10Ω,1%,1/8W,Thick Film,0805	RS-05K100FT	Fenghua

Typical System Application– PWM dimming circuit

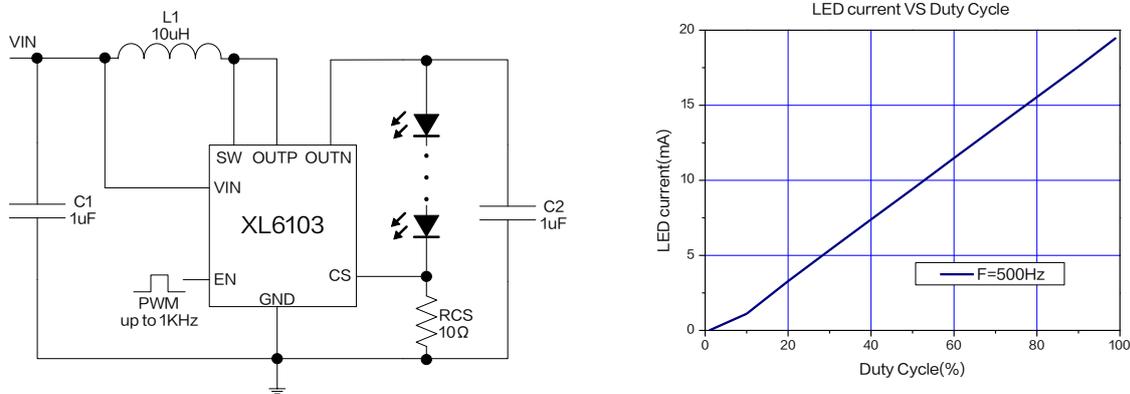
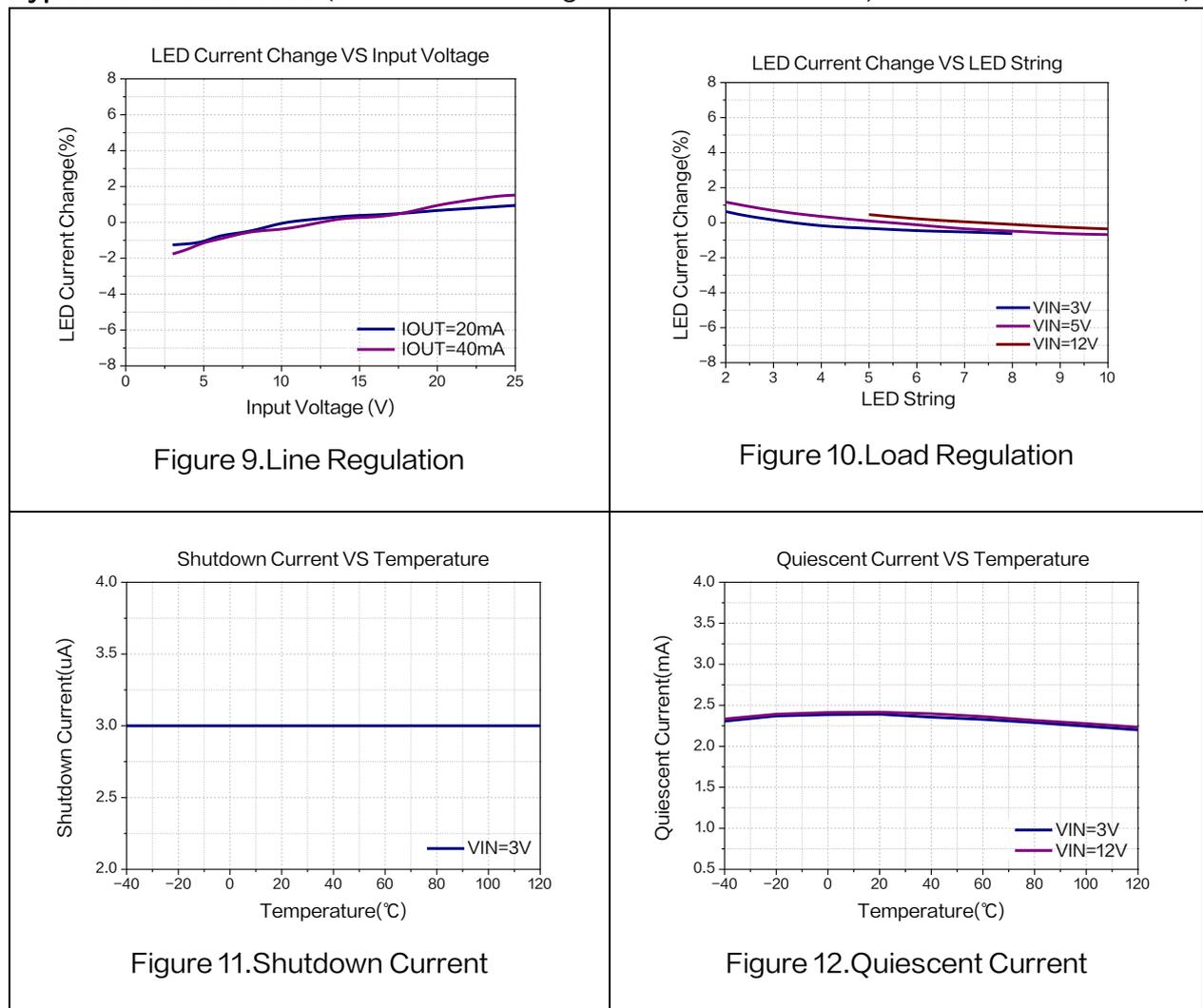


Figure8. XL6103 Dimming circuit and PWM dimming curve

Typical Characteristics (LED forward voltage V_F is 3.3V at $I_F=20\text{mA}$, unless otherwise noted.)



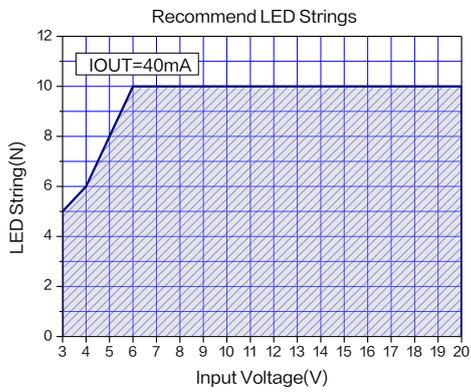


Figure 13. Max LED Strings ($I_{OUT}=40mA$)

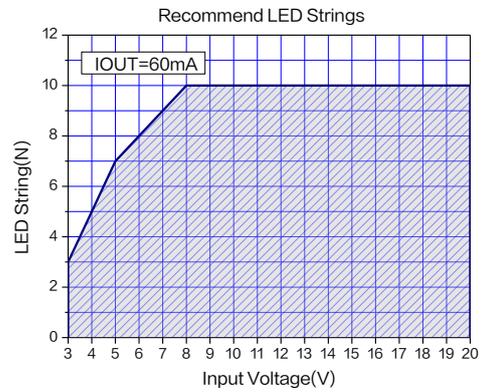


Figure 14. Max LED Strings ($I_{OUT}=60mA$)

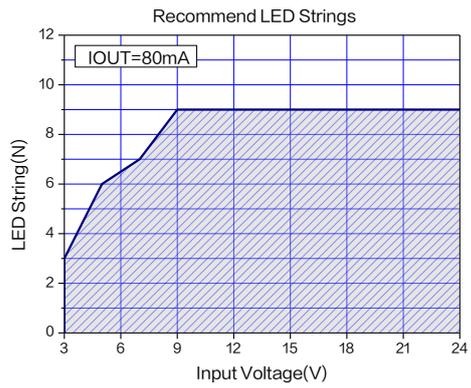


Figure 15. Max LED Strings ($I_{OUT}=80mA$)

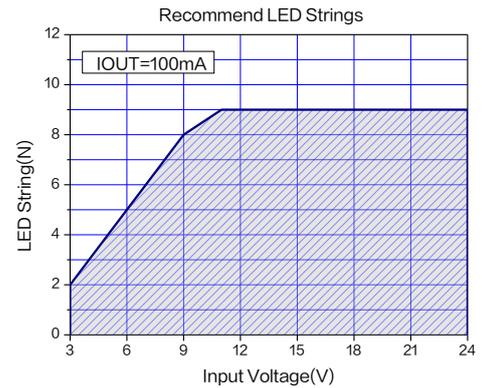


Figure 16. Max LED Strings ($I_{OUT}=100mA$)

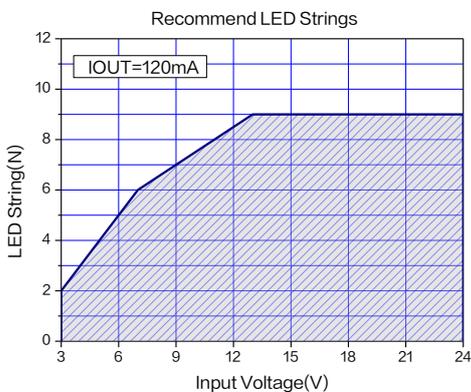


Figure 17. Max LED Strings ($I_{OUT}=120mA$)

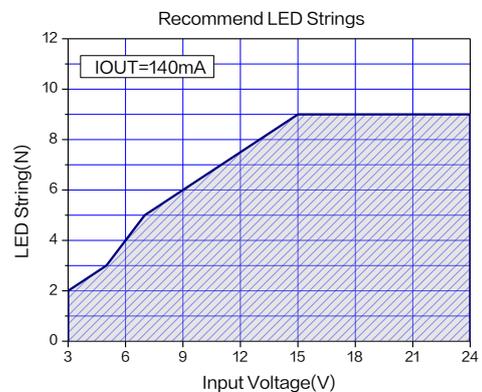
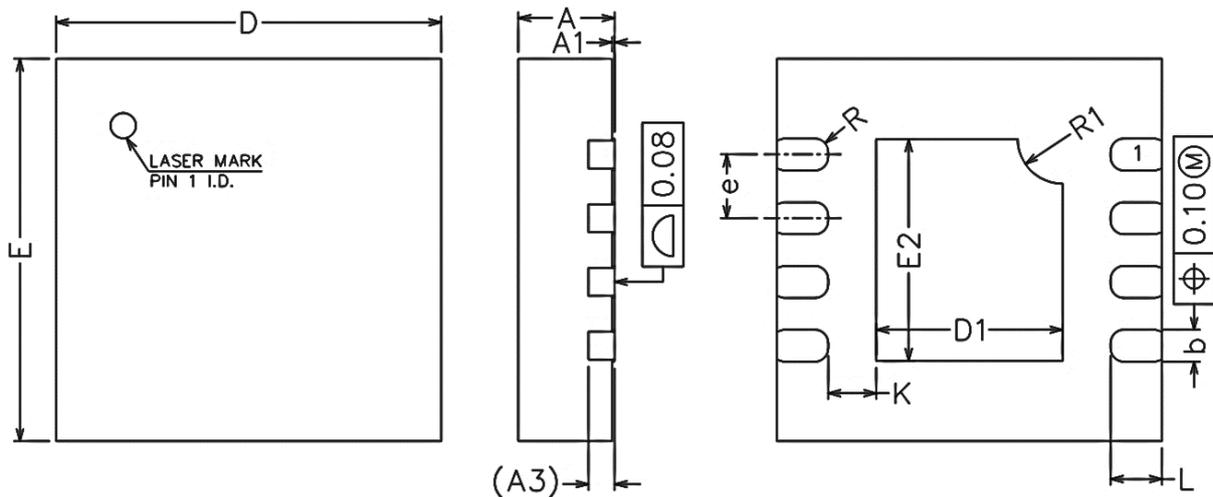


Figure 18. Max LED Strings ($I_{OUT}=140mA$)

Package Information

DFN3*3-8



Symbol	Dimensions In Millimeters			Dimensions In Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	0.700	0.750	0.800	0.027	0.030	0.032
A1	0.000	0.020	0.050	0.000	0.001	0.002
A3	0.203 REF.			0.008 REF.		
b	0.200	0.250	0.300	0.007	0.010	0.012
D	2.900	3.000	3.100	0.114	0.118	0.122
E	2.900	3.000	3.100	0.114	0.118	0.122
D2	1.350	1.450	1.550	0.053	0.057	0.061
E2	1.640	1.740	1.840	0.064	0.068	0.072
e	0.400	0.500	0.600	0.016	0.020	0.024
K	0.275	0.375	0.475	0.011	0.015	0.019
L	0.300	0.400	0.500	0.012	0.016	0.020
R	0.100 REF.			0.004 REF.		
R1	0.350 REF.			0.014 REF.		

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